

Product Summary

$V_{(BR)DSS}$	$R_{DS(on)MAX}$	I_D
200V	12mΩ@10V	100A

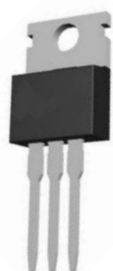
Feature

- Excellent gate charge x $R_{DS(on)}$ product
- Very low on-resistance $R_{DS(on)}$
- 175°C operating temperature
- Suffix "-Q1" for AEC-Q101

Application

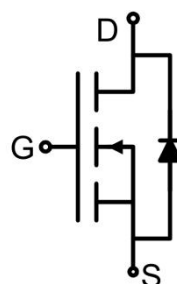
- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

Package

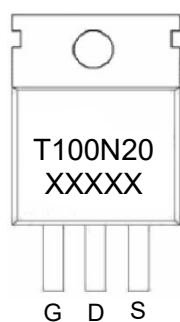


TO-220AB

Circuit diagram



Marking



Absolute maximum ratings (T_c=25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V _{DS}	200	V
Gate-Source Voltage	V _{GS}	±20	V
Continuous Drain Current	I _D	100	A
Continuous Drain Current(T _c =100°C)	I _D (100°C)	70.7	A
Pulsed Drain Current	I _{DM}	400	A
Power Dissipation	P _D	300	W
Thermal Resistance,Junction-to-Case	R _{θJC}	0.5	°C/W
Single pulse avalanche energy ¹⁾	E _{AS}	1216	mJ
Junction Temperature	T _J	175	°C
Storage Temperature	T _{STG}	-55 ~ +175	°C

Electrical characteristics (T_c=25 °C unless otherwise noted)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static Characteristics						
Drain-source breakdown voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D =250μA	200			V
Zero gate voltage drain current	I _{DSS}	V _{DS} =200V, V _{GS} = 0V			1	μA
Gate-body leakage current	I _{GSS}	V _{GS} =±20V, V _{DS} = 0V			±100	nA
Gate threshold voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	2.5		4.5	V
Drain-source on-resistance	R _{DS(on)}	V _{GS} =10V, I _D =50A		10	12	mΩ
Dynamic characteristics ²⁾						
Input Capacitance	C _{iss}	V _{DS} =100V, V _{GS} =0V, f =1.0MHz		6000		pF
Output Capacitance	C _{oss}			425		
Reverse Transfer Capacitance	C _{rss}			16		
Total Gate Charge	Q _g	V _{DS} =100V, V _{GS} =10V, I _D =50A		87		nC
Gate-Source Charge	Q _{gs}			32		
Gate-Drain Charge	Q _{gd}			17.5		
Turn-on delay time	t _{d(on)}	V _{DD} =100V, V _{GS} =10V, I _D =50A, R _G =4.7Ω		18		nS
Turn-on rise time	t _r			26		
Turn-off delay time	t _{d(off)}			41		
Turn-off fall time	t _f			11		
Source-Drain Diode characteristics						
Diode Forward Current	I _S				100	A
Diode Forward voltage	V _{SD}	V _{GS} =0V, I _S =100A			1.2	V
Reverse Recovery Time	T _{rr}	T _J = 25°C, I _F =50A di/dt = 100A/μs		140		nS
Reverse Recovery Charge	Q _{rr}			600		nC

Notes:

1) EAS condition : T_J=25°C, V_{DD}=50V, V_G=10V, L=0.5mH, R_G=25Ω

2) Guaranteed by design, not subject to production

3) These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of T_J(MAX)=175°C. The SOA curve provides a single pulse rating.

Typical Characteristics

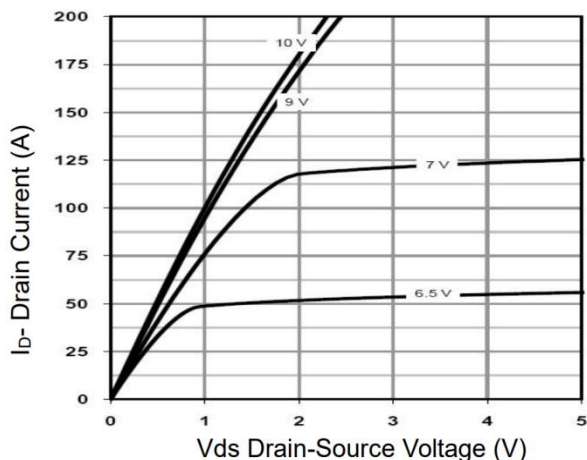


Figure 1 Output Characteristics

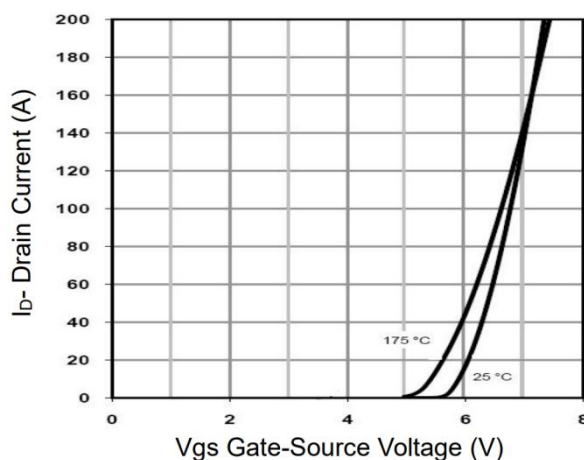


Figure 2 Transfer Characteristics

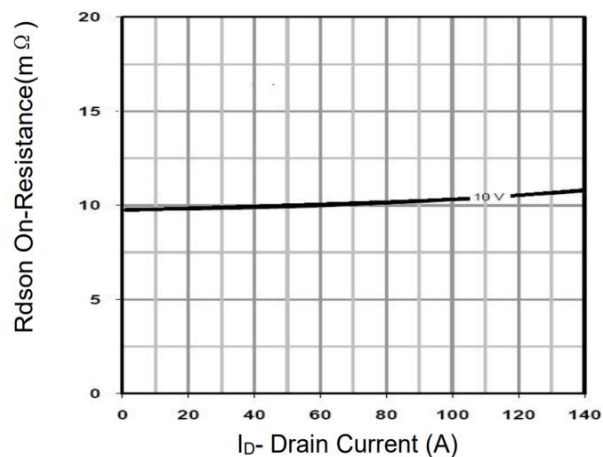


Figure 3 Rdson- Drain Current

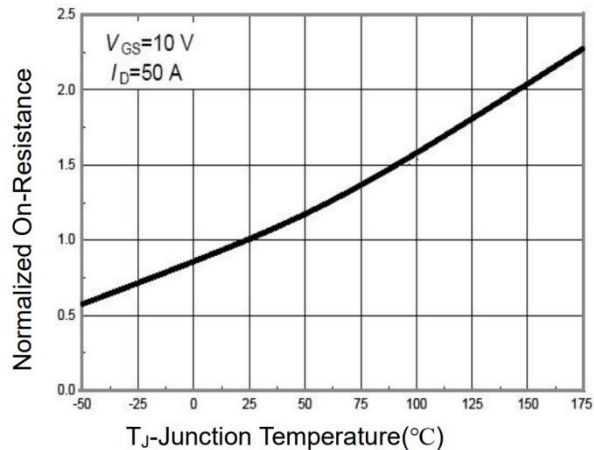


Figure 4 Rdson-Junction Temperature

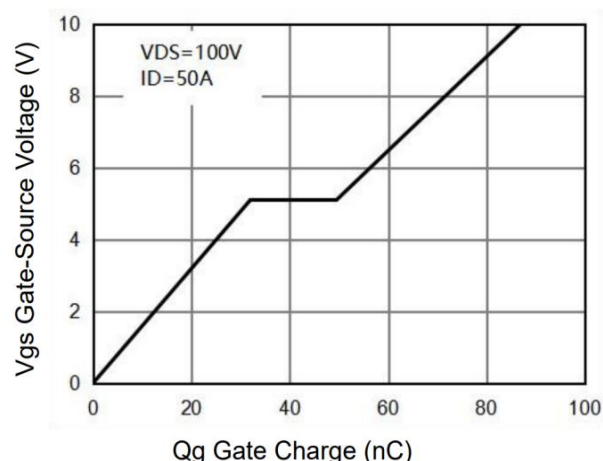


Figure 5 Gate Charge

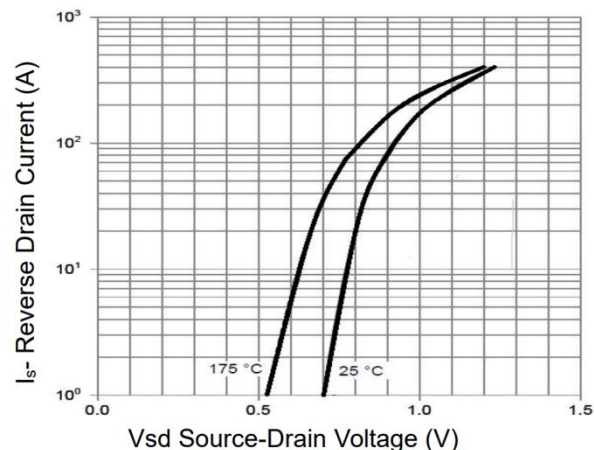


Figure 6 Source- Drain Diode Forward

Typical Characteristics

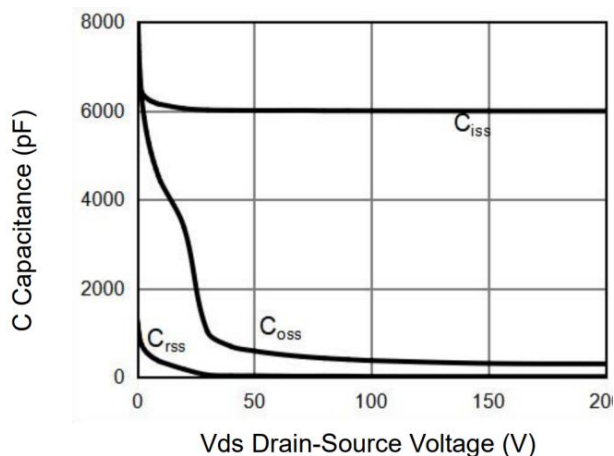


Figure 7 Capacitance vs Vds

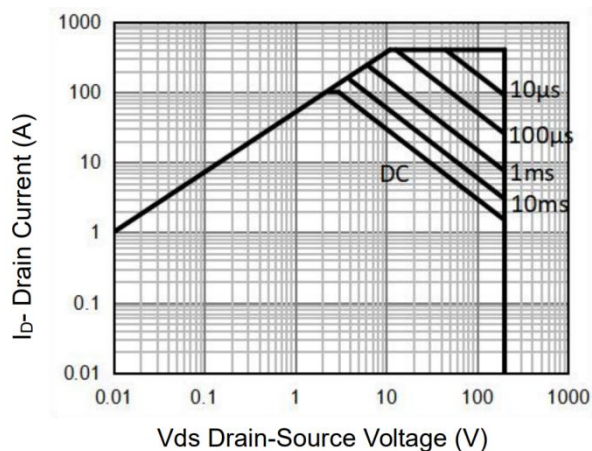


Figure 8 Safe Operation Area (Note 3)

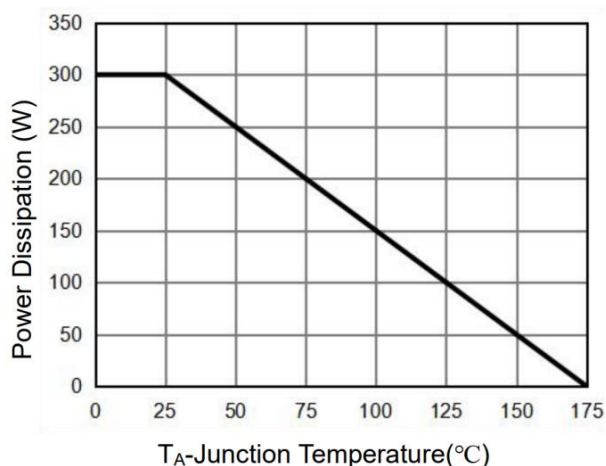


Figure 9 Power De-rating

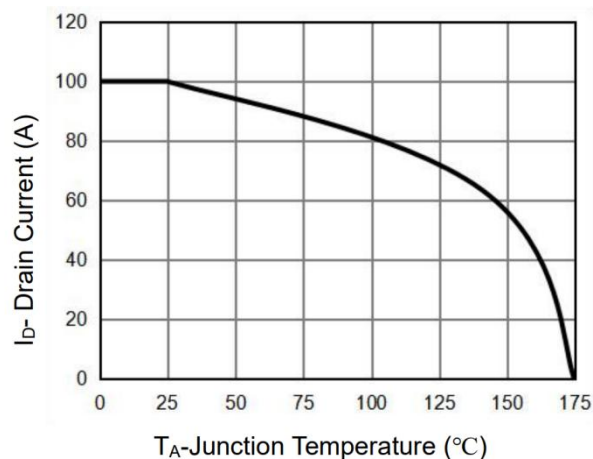


Figure 10 Current De-rating

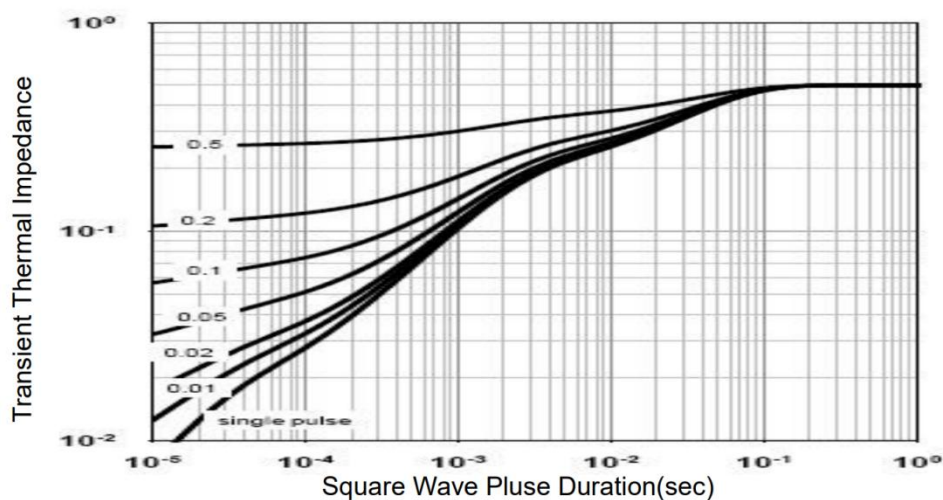
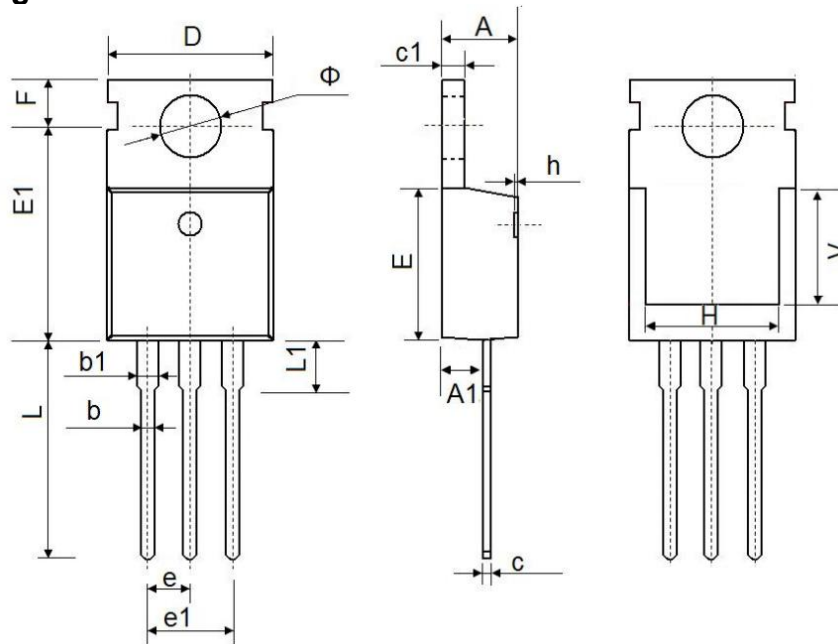


Figure 11 Normalized Maximum Transient Thermal Impedance

TO-220AB Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	4.400	4.600	0.173	0.181
A1	2.250	2.550	0.089	0.100
b	0.710	0.910	0.028	0.036
b1	1.170	1.370	0.046	0.054
c	0.330	0.650	0.013	0.026
c1	1.200	1.400	0.047	0.055
D	9.910	10.250	0.390	0.404
E	8.950	9.750	0.352	0.384
E1	12.650	12.950	0.498	0.510
e	2.540 TYP		0.100 TYP	
e1	4.980	5.180	0.196	0.204
F	2.650	2.950	0.104	0.116
H	7.900	8.100	0.311	0.319
h	0.000	0.300	0.000	0.012
L	12.900	13.400	0.508	0.528
L1	2.850	3.250	0.112	0.128
V	7.500 REF		0.295 REF	
Φ	3.400	3.800	0.134	0.150